LV5686PVC

Bi-CMOS LSI

Multi-Power Supply IC for Car Audio Systems

ON Semiconductor®

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Overview

LV5686PVC is a multiple voltage regulator for Car Audio System. This IC has 3 voltage regulators, 5V output for a microcontroller, 9.85V output for illuminations, 9V output for audio control and 6 high side switches.

About protection circuits, it has Over-current-protection, Over-voltage-protection and Thermal-shut-down. This IC is most suitable for Car Audio System.

Features

- 3 system regulators
    - V_{DD} (MCU) : V_{OUT} 5V, I_{OUT} max 300mA, reverse current prevention.
    - Illumination : V_{OUT} 9.85V, I_{OUT} max 300mA
    - Audio : V_{OUT} 9.0V, I_{OUT} max 500mA
- 6 high side switches
    - AMP : I_{OUT} max 300mA, voltage difference between input and output: 1.0V
    - ANT : I_{OUT} max 300mA, voltage difference between input and output: 1.0V
    - EXT1 : I_{OUT} max 500mA, voltage difference between input and output: 1.0V
    - EXT2 : I_{OUT} max 500mA, voltage difference between input and output: 1.0V
    - EXT3 : I_{OUT} max 350mA, voltage difference between input and output: 0.5V
    - EXT4 : I_{OUT} max 500mA, voltage difference between input and output: 1.0V
- Over Current Protection
- BATT. Detection: under voltage1 (<6.5V), under voltage2 (<9.5V) and over voltage (>18V)
- Over Voltage Protection Typ 25V (shutdown except V_{DD})
- Thermal Shut Down Circuit Typ 175°C
- Applied P-LDMOS to Output stage

(Warning) The protector functions only improve the IC's tolerance and they do not guarantee the safety of the IC if used under the conditions out of safety range or ratings. Use of the IC such as use under overcurrent protection range, thermal shutdown state or V6IN OVS condition may degrade the IC's reliability and eventually damage the IC.

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Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Conditions	Conditions		Ratings	Unit
Maximum supply voltage	V_{CC} max			36	V
Allowable power dissipation	Pd max	Independent IC	Ta ≤ 25°C	1.3	W
		Al heat sink *		5.3	W
		With an infinity heat sink		26.0	W
Peak supply voltage	V_{CC} peak	See below for the waveform applied.		50	V
Operating ambient temperature	Topr			-40 to +85	°C
Storage temperature	Tstg			-55 to +150	°C
Junction temperature	Tj max			150	°C

* : When the Aluminum heat sink (50mm × 50mm × 1.5mm) is used

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Waveform of surge test
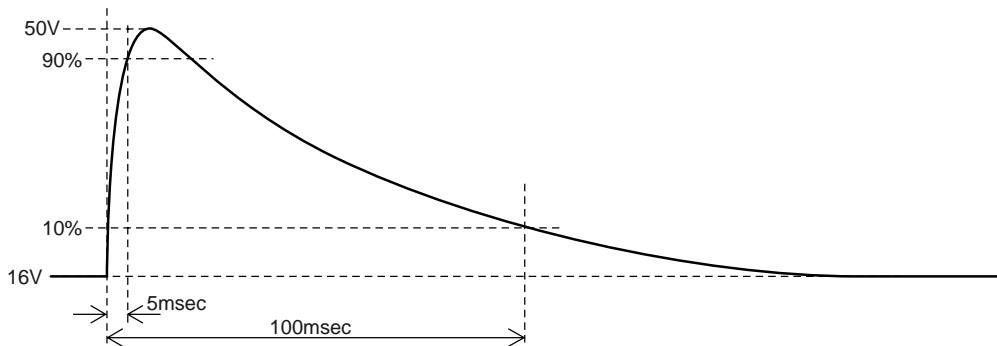
Recommended Operating Range at Ta = 25°C

Parameter	Conditions	Ratings	Unit
Operating supply voltage 1	V_{DD}(5V)	6.5 to 16	V
Operating supply voltage 2	AUDIO(9V)	11.5 to 16	V
Operating supply voltage 3	ILM(9.85V)	12.5 to 16	V
Operating supply voltage 4	AMP, ANT, EXT1, EXT2, EXT3, EXT4	7.5 to 16	V

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Electrical Characteristics (1) at Ta = 25°C, V_{CC} = 14.4V (*1)

Parameter	Symbol	Conditions	min	typ	max	Unit
Quiescent current	I_{CC}	V_{DD} No Load, EN/CTRL1/2 =⌈L/L/L⌋		60	100	μA
EN (AUDIO, ILM, AMP, EXT1 control)						
⌈L⌋ input voltage	$V_{IL}1$	All: OFF	0		0.3	V
⌈M⌋ input voltage	$V_{IM}1$	AUDIO, ILM, EXT1: ON	1.1	1.65	2.1	V
⌈H⌋ input voltage	$V_{IM}1$	All: ON	2.7	3.3	5.5	V
Input impedance	$R_{IN}1$	Input voltage ≤ 3.3V	280	400	520	kΩ
CTRL1 (EXT2, EXT4 control)						
⌈L⌋ input voltage	$V_{IL}2$	All: OFF	0		0.3	V
⌈M⌋ input voltage	$V_{IM}2$	EXT2: ON	1.1	1.65	2.1	V
⌈H⌋ input voltage	$V_{IM}2$	All: ON	2.7	3.3	5.5	V
Input impedance	$R_{IN}2$	Input voltage ≤ 3.3V	280	400	520	kΩ
CTRL2 (ANT, EXT3 control)						
⌈L⌋ input voltage	$V_{IL}3$	All: OFF	0		0.3	V
⌈M⌋ input voltage	$V_{IM}3$	ANT: ON	1.1	1.65	2.1	V
⌈H⌋ input voltage	$V_{IM}3$	All: ON	2.7	3.3	5.5	V
Input impedance	$R_{IN}3$	Input voltage ≤ 3.3V	280	400	520	kΩ
V_{DD} output 5V (reverse current prevention diode implemented)						
V_{DD} output voltage	V_O1	I_O1 = 200mA	4.75	5.0	5.25	V
V_{DD} output current	I_O1	V_O1 > 4.7V	300			mA
Line regulation	$\Delta V_{OLN}1$	7.5V < V_{CC} < 16V, I_O1 = 200mA		30	60	mV
Load regulation	$\Delta V_{OLD}1$	1mA < I_O1 < 200mA		70	140	mV
Dropout voltage	$V_{DROP}1$	I_O1 = 150mA		1.25	1.5	V
Ripple rejection	$R_{REJ}1$	f = 120Hz, I_O1 = 200mA	40	50		dB
V_{DD} reverse current	Irev	V_O1 = 5V, V_{CC} = 0V		10	100	μA
ILM output 9.85V-ON ; EN =⌈M⌋, ⌈H⌋						
ILM output voltage	V_O2	I_O2 = 200mA	9.36	9.85	10.34	V
ILM output current	I_O2	V_O2 > 9.2V	300			mA
Line regulation	$\Delta V_{OLN}2$	12.5V < V_{CC} < 16V, I_O2 = 200mA		30	60	mV
Load regulation	$\Delta V_{OLD}2$	1mA < I_O2 < 200mA		70	140	mV
Dropout voltage	$V_{DROP}2$	I_O2 = 200mA		1.0	1.5	V
Ripple rejection	$R_{REJ}2$	f = 120Hz, I_O2 = 200mA	40	50		dB

(*1) All the specification is defined based on the tests performed under the conditions where Tj and Ta(=25°C) are almost equal. These tests were performed with pulse load to minimize the increase of junction temperature (Tj).

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**Electrical Characteristics (2)** at Ta = 25°C, V_{CC} = 14.4V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
AUDIO output 9.0V -ON ; EN = ⌈M⌋, ⌈H⌋						
AUDIO output voltage	V_O3	I_O3 = 400mA	8.55	9.0	9.45	V
AUDIO output current	I_O3	V_O3 > 8.5V	500			mA
Line regulation	$\Delta V_{OLN}3$	11.5V < V_{CC} < 16V, I_O3 = 400mA		40	80	mV
Load regulation	$\Delta V_{OLD}3$	1mA < I_O3 < 400mA		70	140	mV
Dropout voltage	$V_{DROP}3$	I_O3 = 200mA		0.6	1.0	V
Ripple rejection	$R_{REJ}3$	f = 120Hz, I_O3 = 200mA	45	60		dB
AMP Remote-ON ; EN = ⌈H⌋						
Output voltage	V_O4	I_O4 = 300mA	V_{CC}-1.8	V_{CC}-1.0		V
Output current	I_O4	$V_O4 \geq V_{CC}$-1.8	300			mA
ANT Remote-ON ; CTRL2 = ⌈M⌋, ⌈H⌋						
Output voltage	V_O5	I_O5 = 300mA	V_{CC}-1.8	V_{CC}-1.0		V
Output current	I_O5	$V_O5 \geq V_{CC}$-1.8	300			mA
EXT1-ON ; EN = ⌈M⌋, ⌈H⌋						
Output voltage	V_O6	I_O6 = 500mA	V_{CC}-1.8	V_{CC}-1.0		V
Output current	I_O6	$V_O6 \geq V_{CC}$-1.8	500			mA
EXT2-ON ; CTRL1 = ⌈M⌋, ⌈H⌋						
Output voltage	V_O7	I_O7 = 500mA	V_{CC}-1.8	V_{CC}-1.0		V
Output current	I_O7	$V_O7 \geq V_{CC}$-1.8	500			mA
EXT3-ON ; CTRL2 = ⌈H⌋						
Output voltage	V_O8	I_O8 = 350mA	V_{CC}-1.8	V_{CC}-1.0		V
Output current	I_O8	$V_O8 \geq V_{CC}$-1.0	350			mA
EXT4-ON ; CTRL1 = ⌈H⌋						
Output voltage	V_O9	I_O9 = 500mA	V_{CC}-1.8	V_{CC}-1.0		V
Output current	I_O9	$V_O9 \geq V_{CC}$-1.8	500			mA

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Electrical Characteristics (3) at Ta = 25°C, V_{CC} = 14.4V

Parameter	Symbol	Conditions	min	typ	max	Unit
BATT.DET output: V_{CC} voltage detection						
BATT.DET output voltage	Voff	I_{OL} = 1mA, undetected.		0.3	0.4	V
BATT.DET output voltage	Von	I_{OH} = -1mA, Under-voltage1	V_{DD}-0.4	V_{DD}-0.3		V
Under-voltage detect threshold1	VthL1	V_{CC} falling, BATT.DET: "Hi-Z" → "Hi"	6.3	6.5	6.7	V
Under-voltage release threshold1	VthL1r	V_{CC} rising	6.8	7.0	7.2	V
Under-voltage1 Hysteresis	Vuv1hys		0.4	0.5	0.6	V
Under-voltage detect threshold2	VthL2	V_{CC} falling, BATT.DET: "Lo" → "Hi-Z"	9.25	9.5	9.75	V
Under-voltage release threshold2	VthL2r	V_{CC} rising	9.75	10	10.25	V
Under-voltage2 Hysteresis	Vuv2hys		0.4	0.5	0.6	V
Over-voltage detect threshold	VthH	V_{CC} rising, BATT.DET: "Lo" → "Hi-Z"	17	18	19	V
Over-voltage release threshold	VthHr	V_{CC} falling	16.5	17.5	18.5	V
Over-voltage Hysteresis	Vovhys		0.4	0.5	0.6	V
Overvoltage shutdown	Vovp	no hysteresis	22.5	25	27.5	V

*V_{CC} voltage detection & over-voltage shutdown
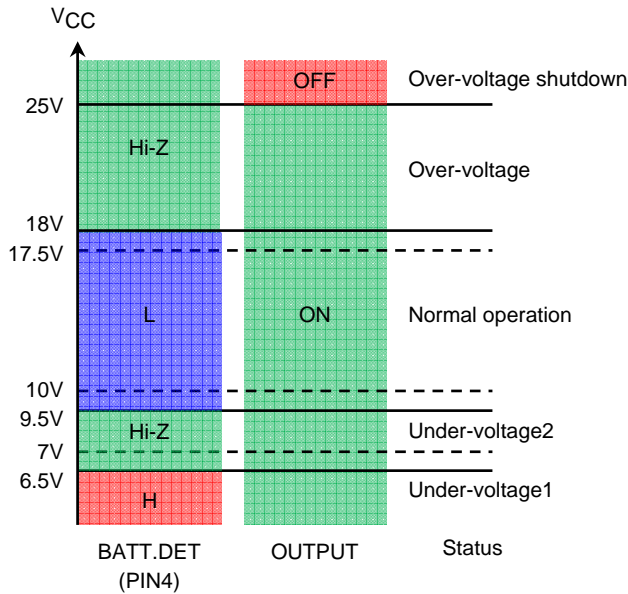
CTRL terminal truth table

EN	EXT1	AUDIO	ILM	AMP
L	OFF	OFF	OFF	OFF
M	ON	ON	ON	OFF
H	ON	ON	ON	ON

CTRL1	EXT2	EXT4
L	OFF	OFF
M	ON	OFF
H	ON	ON

CTRL2	ANT	EXT3
L	OFF	OFF
M	ON	OFF
H	ON	ON

EN/CTRL1/CTRL2 voltage range and threshold
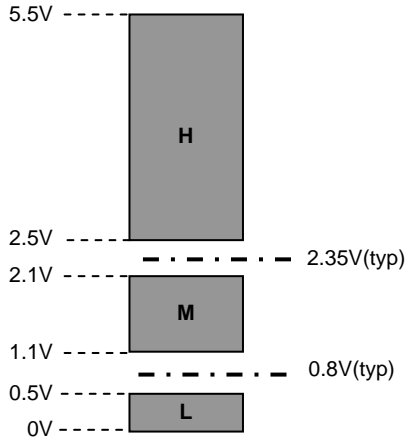
Package Dimensions

unit : mm (typ)
3336
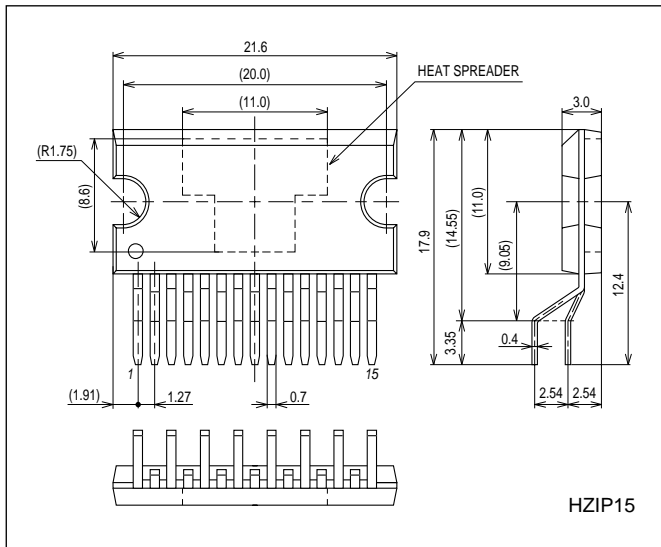
• Allowable power dissipation derating curve

Pd max − Ta
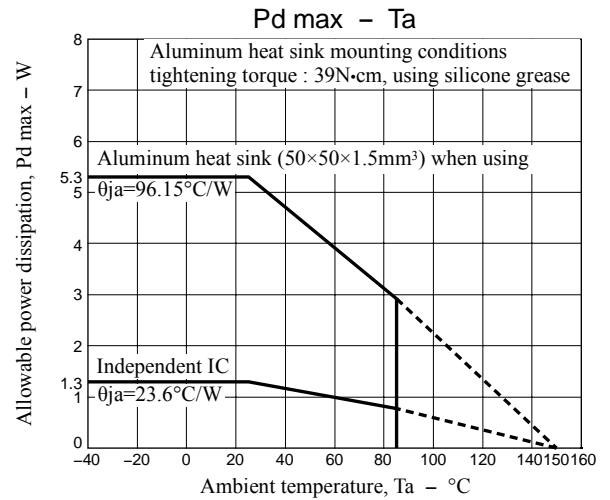
Pin assignment

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Pin	Name
1	AMP
2	ANT
3	EXT1
4	B.DET
5	VDD
6	EN
7	VCC
8	CTRL1
9	AUDIO
10	CTRL2
11	EXT2
12	EXT3
13	EXT4
14	GND
15	ILM
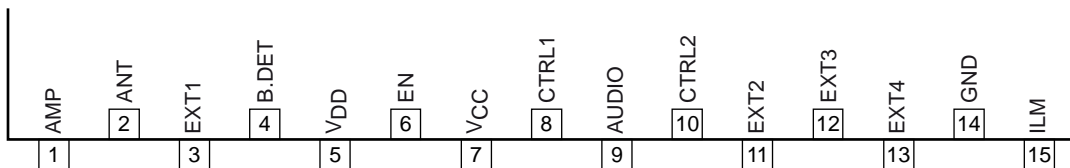
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Application Circuit Example

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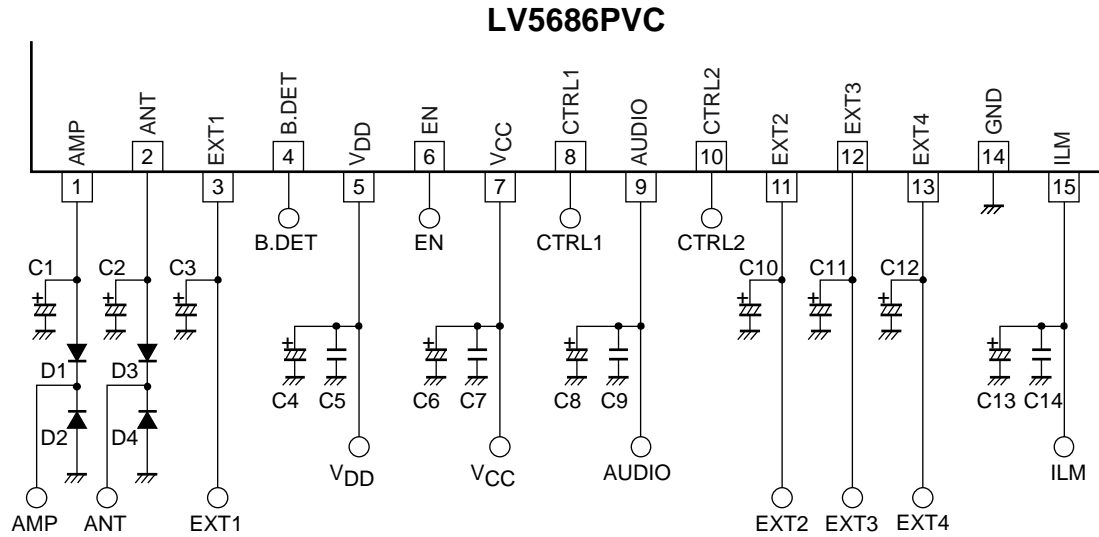
Peripheral parts

Part name	Description	Recommended value	Note
C1, C2, C3, C10, C11, C12	output stabilization capacitor for high-side switches	greater than 2.2μF	
C4, C8, C13	output stabilization capacitor	greater than10μF (*1)	
C5, C9, C14	output stabilization capacitor	greater than0.22μF (*1)	Ceramic capacitor
C6	Capacitor for bypass power supply	greater than 100μF	Make sure to implement close to V_{CC} and GND.
C7	Capacitor for oscillation protector	greater than 0.22μF	
D1, D2, D3, D4	Internal device protector diode	SB1003M3	(*2)

Note: Circuit diagram and the values are only tentative and subject to change.

(*1) Make sure that total capacitance of regulator output is greater than 10μF and meets the condition of ESR = 0.001 to 10Ω , in which voltage/temperature dependence and unit differences are taken into consideration. Moreover, in case of electrolytic capacitor, high-frequency characteristics should be sufficiently good.

(*2) These parts are necessary if output voltage of high-side switches gets lower than GND or higher than V_{CC}. The same consideration is required on EXT1 through EXT4.

Block Diagram
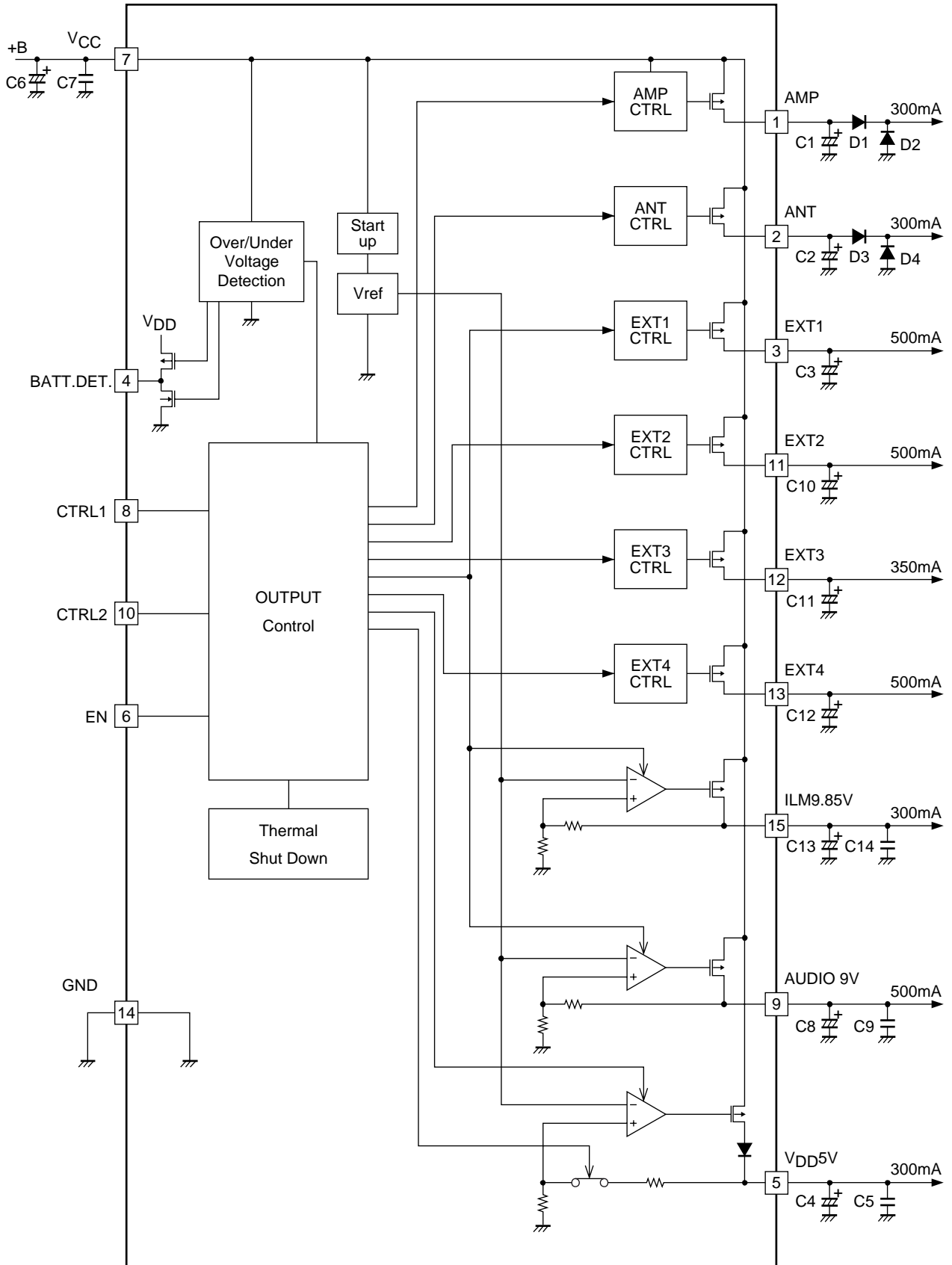
Pin Function

Pin No.	Pin name	Description	Equivalent Circuit
1	AMP	AMP output When EN = H, AMP is ON V_{CC}-1V/300mA	
2	ANT	ANT output When CTRL2 = M or H, ANT is ON V_{CC}-1V/300mA	
3	EXT1	EXT1 output When EN = M or H, EXT1 is ON V_{CC}-1V/500mA	
4	BATT.DET	Battery voltage detector output L : 9.5V<V_{CC}<18V HiZ : 6.5V<V_{CC}<9.5V or V_{CC}>18V H (V_{DD}) : V_{CC}<6.5V	

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Pin No.	Pin name	Description	Equivalent Circuit
5	V_{DD}	V_{DD} output, 5.0V/0.3A	
6 8 10	EN CTRL1 CTRL2	Control input 3-value input	
7	V_{CC}	Power supply	
9	AUDIO	AUDIO output When EN = M or H, AUDIO is ON 9V/0.5A	
11	EXT2	EXT2 output When CTRL1 = M or H, EXT2 is ON V_{CC}-1V/500mA	

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Pin No.	Pin name	Description	Equivalent Circuit
12	EXT3	EXT3 output When CTRL2 = H, EXT3 is ON V_{CC}-0.5V/350mA	
13	EXT4	EXT4 output When CTRL1 = H, EXT4 is ON V_{CC}-1V/500mA	
14	GND		
15	ILM	ILM output When EN = M or H, ILM is ON 9.85V/0.3A	

Timing Chart

V_CC (PIN7) — 14.4V, 7V, 10V, 25V, 18V, 10V, 17.5V, 9.5V, 6.5V, 10V, 7V

V_DD output (PIN5)

EN (PIN6) — L, M, H

CTRL1 (PIN8) — L, M, H

CTRL2 (PIN10) — L, M, H

ILM output (PIN15)

AUDIO output (PIN9)

EXT1 output (PIN3)

EXT2 output (PIN11)

EXT3 output (PIN12)

EXT4 output (PIN13)

ANT output (PIN2)

AMP output (PIN1)

BATT.DET (PIN4) — V_DD-0.3V

(Hi-Z state)
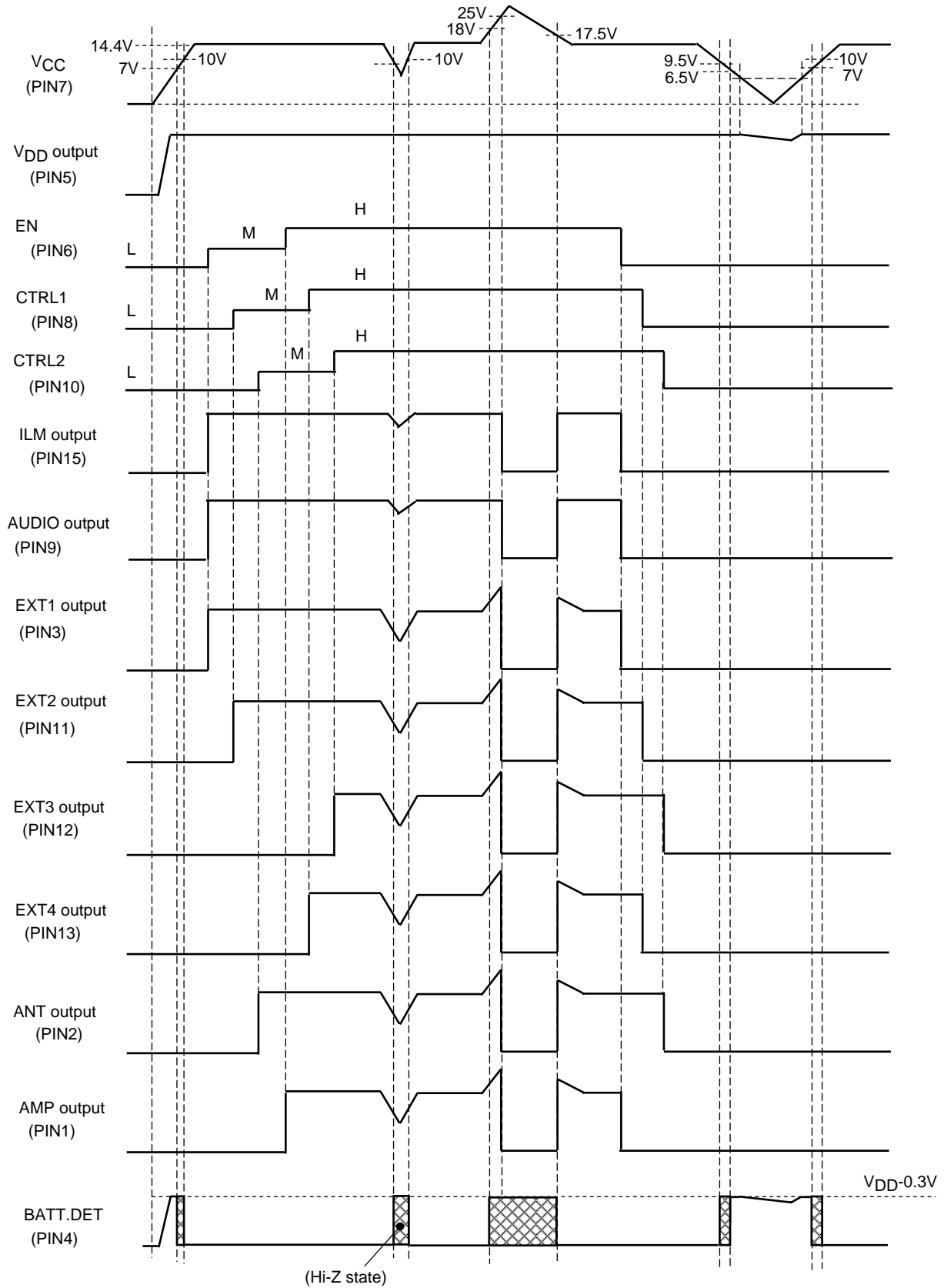
HZIP15 Heat sink attachment

Heat sinks are used to lower the semiconductor device junction temperature by leading the head generated by the device to the outer environment and dissipating that heat.

a. Unless otherwise specified, for power ICs with tabs and power ICs with attached heat sinks, solder must not be applied to the heat sink or tabs.

b. Heat sink attachment
    • Use flat-head screws to attach heat sinks.
    • Use also washer to protect the package.
    • Use tightening torques in the ranges 39-59Ncm(4-6kgcm) .
    • If tapping screws are used, do not use screws with a diameter larger than the holes in the semiconductor device itself.
    • Do not make gap, dust, or other contaminants to get between the semiconductor device and the tab or heat sink.
    • Take care a position of via hole .
    • Do not allow dirt, dust, or other contaminants to get between the semiconductor device and the tab or heat sink.
    • Verify that there are no press burrs or screw-hole burrs on the heat sink.
    • Warping in heat sinks and printed circuit boards must be no more than 0.05 mm between screw holes, for either concave or convex warping.
    • Twisting must be limited to under 0.05mm.
    • Heat sink and semiconductor device are mounted in parallel.
      Take care of electric or compressed air drivers
    • The speed of these torque wrenches should never exceed 700 rpm, and should typically be about 400 rpm.
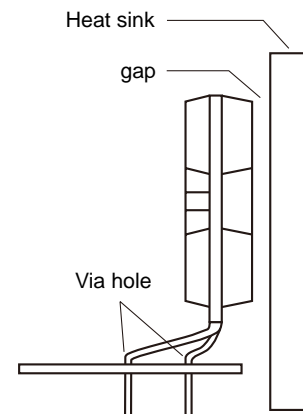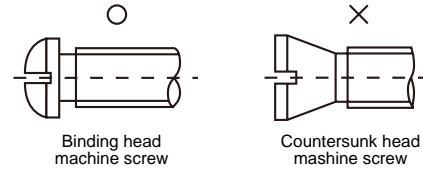
c. Silicone grease
    • Spread the silicone grease evenly when mounting heat sinks.
    • Our company recommends YG-6260 (Momentive Performance Materials Japan LLC)

d. Mount
    • First mount the heat sink on the semiconductor device, and then mount that assembly on the printed circuit board.
    • When attaching a heat sink after mounting a semiconductor device into the printed circuit board, when tightening up a heat sink with the screw, the mechanical stress which is impossible to the semiconductor device and the pin doesn't hang.

e. When mounting the semiconductor device to the heat sink using jigs, etc.,
    • Take care not to allow the device to ride onto the jig or positioning dowel.
    • Design the jig so that no unreasonable mechanical stress is applied to the semiconductor device.

f. Heat sink screw holes
    • Be sure that chamfering and shear drop of heat sinks must not be larger than the diameter of screw head used.
    • When using nuts, do not make the heat sink hole diameters larger than the diameter of the head of the screws used. A hole diameter about 15% larger than the diameter of the screw is desirable.
    • When tap screws are used, be sure that the diameter of the holes in the heat sink are not too small. A diameter about 15% smaller than the diameter of the screw is desirable.

g. There is a method to mount the semiconductor device to the heat sink by using a spring band. But this method is not recommended because of possible displacement due to fluctuation of the spring force with time or vibration.

○   ×

Binding head   Countersunk head
machine screw   mashine screw

Heat sink

gap

Via hole

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